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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/726,490	12/04/2003	Zi-Ping Chen	681954-45UI	7535
570 7590 05/07/2007 AKIN GUMP STRAUSS HAUER & FELD L.L.P. ONE COMMERCE SQUARE 2005 MARKET STREET, SUITE 2200 PHILADELPHIA, PA 19103			EXAMINER BAUER, SCOTT ALLEN	
			ART UNIT 2836	PAPER NUMBER
			MAIL DATE 05/07/2007	DELIVERY MODE PAPER

**Please find below and/or attached an Office communication concerning this application or proceeding.**

The time period for reply, if any, is set in the attached communication.

## Office Action Summary

Application No.

10/726,490

Applicant(s)

CHEN ET AL.

Examiner

Scott Bauer

Art Unit

2836

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

### Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

### Status

- 1) ☒ Responsive to communication(s) filed on 12 December 2006.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

### Disposition of Claims

- 4) ☒ Claim(s) 1-7 and 16-32 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 1-7 and 16-32 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

### Application Papers

- 9) ☒ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 04 December 2003 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

### Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some \* c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
  2. ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

\* See the attached detailed Office action for a list of the certified copies not received.

### Attachment(s)

- |  |   |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892)                     | 4) <input type="checkbox"/> Interview Summary (PTO-413)           |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____                                      |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)          | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____  | 6) <input type="checkbox"/> Other: _____                          |

Art Unit: 2836

## DETAILED ACTION

### *Specification*

It is believed that there is a spelling error in the title. The following title is suggested: "**Silicon**-controlled rectifier with dynamic holding voltage for on-chip electrostatic discharge protection".

### *Claim Rejections - 35 USC § 103*

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

1. Claims 1-7 & 23-27 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lee (US 6,309,940) in view of Lai et al. (US 2002/0089017).

With regard to Claim 1, Lee teaches an integrated circuit comprising: a silicon-controlled rectifier (column 1 lines 20-25); a first transistor (27, 28) of a first type (P-channel FET) integrally formed with the SCR including a first gate (37); a second transistor (25, 26) of a second type (N-channel FET) integrally formed with the SCR including a second gate (38); and a control circuit ( $V_{in}$ ) which provides a first and second voltage to the first and second gates (37 & 38).

Lee does not teach that the control circuit provides a first holding voltage to the SCR to keep the SCR from latching-up, and in response to a second voltage applied to the first and second gates providing a second holding voltage to the SCR to keep the SCR in the latch-up state.

Lai et al., in Figures 7 A&B, teaches an SCR device used to protect an I/O pad wherein a control circuit is coupled to first and second gates of N and P type FETs and that by driving the gates, the control circuit provides a first holding voltage to the SCR to keep the SCR from latching-up, and in response to a second voltage applied to the first and second gates providing a second holding voltage to the SCR to keep the SCR in the latch-up state (paragraph 0057).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teachings of Lee with Lai et al., by coupling the control circuit (244 & 250) taught by Lai et al., at node A, to the control signal ( $V_{in}$ ) of

Lee, for the purpose of avoiding latch-up while the SCR operates at normal condition, but allows for easy triggering of the device in an ESD event (Lai et al. Paragraph 0021).

The integrated circuit taught in Fig. 1 of Lee, is capable of use for electrostatic discharge protection.

With regard to Claims 2-4, Lee in view of Lai et al. discloses the circuit of Claim 1. Lai et al. further discloses that the control circuit further comprises an output terminal (A) coupled to first and second gates. Lai et al. further teaches that the control circuit comprises a resistor (244), a capacitor (250) and an output terminal (A) disposed between the resistor and the capacitor, which provides a resistor-capacitor delay circuit.

With regard to Claims 5-7, Lee in view of Lai et al. discloses the circuit of Claim 1. Lee further discloses that the SCR further comprising a p-type substrate (11), an n-well (21) formed in the p-type substrate, a p-type diffused region (28) formed in the n-well, and an n-type diffused region (25) formed outside of the n-well. Lee further teaches that the first transistor further comprises a channel region formed in the n-well and that the second transistor further comprises a channel region formed in the p-type substrate (column 1 lines 40-44, 55-59).

With regard to Claim 23, Lee teaches a method of electrostatic discharge protection comprising: providing a silicon-controlled rectifier (SCR) having a holding voltage; integrally forming a first transistor (27 & 28) of a first type with the SCR

including a first gate (37); integrally forming a second transistor (25 & 26) of a second type with the SCR including a second gate (38).

Lee does not teach providing a first signal to the first and second gates to raise the holding voltage of the SCR to keep the SCR from latching up; and providing a second signal to the first and second gates to lower the holding voltage of the SCR to keep the SCR in the latch-up state.

Lai et al., in Figures 7 A&B, teaches an SCR device used to protect an I/O pad wherein a control circuit is coupled to first and second gates of N and P type FETs and that by driving the gates, the control circuit provides a first holding voltage to the SCR to keep the SCR from latching-up, and in response to a second voltage applied to the first and second gates providing a second holding voltage to the SCR to keep the SCR in the latch-up state (paragraph 0057).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teachings of Lee with Lai et al., by coupling the control circuit (244 & 250) taught by Lai et al., at node A, to the control signal ( $V_{in}$ ) of Lee, for the purpose of avoiding latch-up while the SCR operates at normal condition, but allows for easy triggering of the device in an ESD event (Lai et al. Paragraph 0021).

The integrated circuit taught in Fig. 1 of Lee, is capable of use for electrostatic discharge protection.

With regard to Claims 24 & 25, Lee in view of Lai et al. discloses the method of Claim 23. Lai et al. further discloses that the method further comprises raising the

holding voltage of the SCR to above a power supply voltage and lowering the holding voltage of the SCR to below a power supply voltage (Lai et al. Paragraph 0057).

With regard to Claim 26, Lee in view of Lai et al. discloses the circuit of Claim 23.

Lee teaches that the SCR is coupled between different voltage lines. Lee does not teach that the SCR is coupled between a contact pad and a voltage line.

Lai et al. In Fig. 4 further discloses that the SCR is coupled between a contact pad (100) and a voltage line (GND).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to place the SCR between a contact pad and voltage line instead of two different voltage lines for the purpose of protecting an internal circuit from an ESD event originating at a contact pad.

With regard to Claim 27, Lee in view of Lai et al. discloses the circuit of Claim 8. Lee et al. Further teaches that the SCR is coupled between different voltage lines (VDD & VSS).

2. Claims 16-22 & 28-32 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lee et al. In view of Lai et al. as applied to claims 1, 8 & 23 above, and further in view of Tong et al. (US 6,756,834).

With regard to Claims 16 & 28, Lee teaches an integrated circuit and a method comprising: a first voltage line (VDD) of a first voltage level; a second voltage line (VSS) of a second voltage level; a silicon-controlled rectifier(SCR), including a p-type transistor and an n-type transistor integrally formed with the SCR.

Lee et al. does not teach a control circuit providing a first holding voltage through the p-type and n-type transistors to the SCR to keep the SCR from latching-up, and providing a second holding voltage through the p-type and n-type transistors to the SCRs to keep the SCRs in the latch-up state during an ESD event that an ESD pulse appears on the first voltage line or one of the contact pads. Further, Lee does not teach providing a plurality of contact pads or that there is a plurality of SCRs.

Lai et al., in Figures 7 A&B, teaches an SCR device used to protect an I/O pad wherein a control circuit is coupled to first and second gates of N and P type FETs and that by driving the gates, the control circuit provides a first holding voltage to the SCR to keep the SCR from latching-up, and in response to a second voltage applied to the first and second gates providing a second holding voltage to the SCR to keep the SCR in the latch-up state (paragraph 0057).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teachings of Lee with Lai et al., by coupling the control circuit (244 & 250) taught by Lai et al., at node A, to the control signal ( $V_{in}$ ) of Lee, for the purpose of avoiding latch-up while the SCR operates at normal condition, but allows for easy triggering of the device in an ESD event (Lai et al. Paragraph 0021).



The integrated circuit taught in Fig. 1 of Lee, is capable of use for electrostatic discharge protection.

Tong et al., in figure 1, discloses an ESD protection circuit comprising a plurality of pads, first and second voltage sources of first and second voltage levels, and a plurality of ESD protection circuits (10 & 14). Tong et al. further teaches that each ESD protection device contains a control circuit comprising a capacitor (16) and a resistor (18).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teachings Lee with Tong et al. by protecting a plurality of I/O pads and voltage lines with the SCR device taught by Lee for the purpose of providing ESD protection to an entire chip assembly instead of just a single voltage source.

With regard to Claim 17 & 29, Lee in view of Lai et al. and further in view of Tong et al. discloses the circuit of Claim 16 and the method of Claim 28. Tong et al. further discloses that an ESD device (14) is coupled between the first and second voltage lines (VCC & VSS) and that the remaining ESDs are each coupled between a corresponding contact pad and the second voltage line.

With regard to Claim 18 & 30, Lee in view of Lai et al. and further in view of Tong et al. discloses the circuit of Claim 17 and the method of Claim 29. Tong et al. further discloses, in Figure 1, that the ESD pulse is discharged from one of the contact pads

Art Unit: 2836

(VCC PAD 1) via a voltage line (VCC1) to voltage line (VSS 1). This event is depicted by PATH\_B in Figure 1.

With regard to Claims 19 & 31 Lee in view of Lai et al. and further in view of Tong et al. discloses the circuit of Claim 17 and the method of Claim 29. Tong et al., in Figure 1, further discloses that an ESD pulse is discharged from the first voltage (VCC 1) line via the second voltage (20) line to one of the contact pads (VSS PAD 1) via PATH\_A.

With regard to Claim 20 & 32, Lee in view of Lai et al. and further in view of Tong et al. discloses the circuit of Claim 17 and the method of Claim 29. Tong et al., in Figure 1, further discloses that an ESD pulse is discharged from one of the contact pads (VCC PAD 1) via the second voltage line (20) to a different contact pad (VSS PAD 1) via PATH\_A.

With regard to Claim 21, Lee in view of Lai et al. and further in view of Tong et al. discloses the circuit of Claim 16. Lai et al. further discloses that the control circuit comprises a resistor-capacitor delay circuit.

With regard to Claim 22, Lee in view of Lai et al. and further in view of Tong et al. discloses the circuit of Claim 16. Lai et al. further discloses that the control circuit

Art Unit: 2836

further comprises an output terminal (A) coupled to a gate of each of the p-type and n-type transistors.

### ***Response to Arguments***

Applicant's arguments filed 12 DEC 2007 have been fully considered but they are not persuasive. Applicants' argue that the rejection of claim 1 was based on improper hindsight combination of the references that would not render all of the required elements of the claim.

Applicants first argue that the Lee reference teaches that the structure is designed to avoid a latch-up condition and thus teaches away from keeping a semiconductor device in latch-up. Firstly, the Lee reference teaches two different SCR devices that teach the structure of the SCR recited in claim 1. The prior art SCR of figure 1 teaches an SCR that is susceptible to an uncontrolled latch-up condition. Lee solves the problem by adding heavily doped regions 105 & 106 to the SCR to prevent an unwanted latch-up condition of an SCR. The Lee reference makes no mention of a control circuit used to hold a holding voltage of the SCR.

Both Lai and the present invention teach a control circuit for setting first and second holding voltages of an SCR. The first holding voltage is applied to prevent the SCR for latching up and the second holding voltage is provided to allow the SCR to trigger. Both Lai and the present invention further disclose that the first holding voltage is to avoid a latch-up condition. In fact Lai teaches that the component (240) in figure 7 is called an "anti-latch up circuit" (paragraph 0057 lines 1-10). As such an SCR that is

less susceptible to accidental latch-up would actually be preferred so that the SCR would not inadvertently be triggered while the first holding voltage is still being applied.

As seen in Figs. 1 & 2 of Lee, a latch-up is prevented by including the heavily doped regions (105 & 106). This creates resistances RS & RW between the gates of the two SCR transistors and their sources. Both Lai and the present invention teach including these resistors in the SCR (as seen in Fig. 7b of Lai). In the control circuit taught by Lai, the addition of these resistors would not affect the operation as the control circuit essentially bypasses these resistors by controlling the gates of the FETs that are integrated with the SCR device. Therefore, the fact that the SCR of Lee avoids an unwanted latch-up condition would not teach away from the combination as this would actually be beneficial in operation as the device would not be inadvertently triggered when the first holding voltage was applied.

Applicants then argue that there is no teaching or suggestion in Lee to cause a person of ordinary skill in the art to combine the two references. In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988) and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, the motivation to combine

was found in the Lai reference (paragraph 0021) and given as motivation to combine the references in the previous action.

Applicants further argue that the combination of Lee and Lai would not successfully result in all of the required elements of claim 1. specifically that the combination would not teach " a control circuit in response to a first voltage applied to the first and second gates providing a first holding voltage to the SCR to keep the SCR from latching up, and in response to a second voltage applied to the first and second providing a second holding voltage to the SCR to keep the SCR in the Latch-up state." Applicants' state that the control circuits applied voltages to transistor gates rather than operating responsive to voltages applied to the transistor gates. However, Lai teaches the that a control circuit operates in response to a first and second voltage applied to the first and second gates providing first and second holding voltages to the SCR to prevent the SCR from latching up in the first case and Keeping the SCR in latched up in the second case. In paragraph 0021, Lai discloses that when a first voltage is applied to a control circuit the holding voltage of the SCR is increase. When an ESD event occurs a second voltage is applied to the control circuit and the holding voltage is lowered to trigger the SCR and thus keep it in latch-up. The circuit of Lai is structurally similar to the present invention as embodied in Fig. 21 & 22 except that the PFET 242 is not integrated into the SCR device. As Lee teaches that both FET devices are integrated into the SCR device, the structure would necessarily perform the above stated function of claim 1 even if Lai didn't disclose the function in paragraph 0057.

With respect to claims 16 & 28, Applicants next argue the combinability of Lee with Lai and Tong. The above arguments with respect to the combinability of Lee and Lai also apply to the arguments of claim 16. In response to applicant's argument that there is no suggestion to combine the references of Lee and Tong, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988) and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, motivation to combine the reference was given in the previous action. Support for this can be found in Tong (column 1 lines 1-17). Further, the Tong reference was brought in to overcome the deficiency that Lee did not teach a plurality of SCR's and contact pads. Even if the motivation to combine Lee with Tong were not taught by Lee or Tong, the combination would still have been found to be obvious since it has been held that mere duplication of the essential working parts of a device involves only routine skill in the art. *St. Regis Paper Co. v. Bemis Co.*, 193 USPQ 8.

### **Conclusion**

**THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Scott Bauer whose telephone number is 571-272-5986. The examiner can normally be reached on M-F 8am-5pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Brian Sircus can be reached on 571-272-2058. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Handwritten signature of Michael Sherry, dated 5/2/07.

MICHAEL SHERRY  
SUPERVISORY PATENT EXAMINER  
TECHNOLOGY CENTER 2800

Art Unit: 2836

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

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